

Title (en)

A method of, and a machine for, electroplating.

Title (de)

Verfahren und Vorrichtung zur Elektroplattierung.

Title (fr)

Procédé et appareillage pour l'électroplacage.

Publication

**EP 0121616 A1 19841017 (EN)**

Application

**EP 83301946 A 19830406**

Priority

EP 83301946 A 19830406

Abstract (en)

There is provided, in a method of selective electroplating, the improvement comprising the utilisation of a highly conductive electrolyte, (8) compatible with the plating electrolyte (7) but containing no depositable metallic ions, to form the cathode connection to the components to be plated and, in a machine for electroplating components, the improvement comprising providing the cathode connection to the components (6) to be plated through the intermediary of a highly conductive electrolyte compatible with the plating electrolyte but containing no depositable metallic ions.

IPC 1-7

**C25D 5/02**

IPC 8 full level

**C25D 5/02** (2006.01)

CPC (source: EP)

**C25D 5/02** (2013.01)

Citation (search report)

- [X] US 4042480 A 19770816 - NOZ FRANCIS X
- [X] US 4007097 A 19770208 - NOZ FRANCIS X
- [A] FR 616544 A 19270203

Designated contracting state (EPC)

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DOCDB simple family (publication)

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